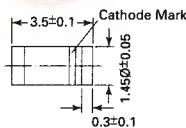


**Silicon Expitaxial Planar Diode**

fast switching diode in MiniMELF case especially suited for automatic surface mounting.



These diodes are delivered taped.  
Details see "Taping".

**Glass case MiniMELF**

Weight approx. 0.05g  
Dimensions in mm

**Absolute Maximum Ratings ( $T_a = 25^\circ\text{C}$ )**

	Symbol	Value	Unit
Reverse Voltage	$V_R$	220	V
Peak Reverse Voltage	$V_{RM}$	250	V
Mean Rectified Current Half Wave Rectification with Resistance load at $T_{amb} = 25^\circ\text{C}$ and $f \geq 50\text{ Hz}$	$I_0$	200	mA
Maximum Forward Current	$I_{FM}$	625	mA
Surge Forward Current at $t < 1\text{ s}$ and $T_j = 25^\circ\text{C}$	$I_{FSM}$	1000	mA
Junction Temperature	$T_j$	175	$^\circ\text{C}$
Storage Temperature Range	$T_s$	-65 to +175	$^\circ\text{C}$

<sup>1)</sup> Valid provided that electrodes are kept at ambient temperature

**Characteristics at  $T_j = 25^\circ\text{C}$** 

	Symbol	Min.	Typ.	Max.	Unit
Forward Voltage at $I_F = 200\text{ mA}$	$V_F$	-	-	1.5	V
Leakage Current at $V_R = 220\text{V}$	$I_R$	-	-	10	$\mu\text{A}$
Reverse Breakdown Voltage tested with 100 $\mu\text{A}$ Pulses	$V_{BR}$	250	-	-	V
Capacitance at $V_F = V_R = 0$ , $f = 1.0\text{ MHz}$	$C_{tot}$	-	-	3	pF
Reverse Recovery Time from $I_F = I_R = 20\text{ mA}$	$t_{rr}$	-	-	75	ns